## **MA2SD310G**

## Silicon epitaxial planar type

For super high speed switching

#### ■ Features

- $I_{F(AV)} = 200$  mA rectification is possible.
- Low forward voltage:  $V_F < 0.47 \text{ V}$  (at  $I_F = 200 \text{ mA}$ )

## ■ Absolute Maximum Ratings $T_a = 25$ °C

Parameter	Symbol	Rating	Unit
Reverse voltage	$V_R$	30	V
Repetitive peak reverse voltage	$V_{RRM}$	30	V
Forward current (Average)	I <sub>F(AV)</sub>	200	mA
Peak forward current	$I_{FM}$	300	mA
Non-repetitive peak forward surge current *	I <sub>FSM</sub>	1	A
Junction temperature	T <sub>j</sub>	125	°C
Storage temperature	$T_{stg}$	-55 to +125	°C

Note) \*: The peak-to-peak value in one cycle of 50 Hz sine wave (non-repetitive)

#### Package

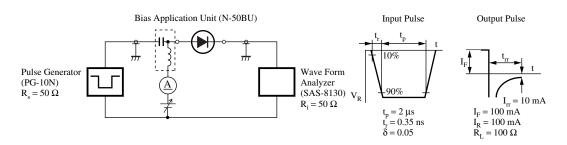
- Code
  - SSMini2-F4
- Pin Name
  - 1: Anode
- 2: Cathode

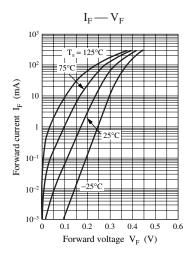
### ■ Marking Symbol: 8F

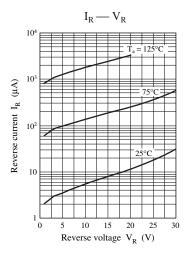
## ■ Electrical Characteristics $T_a = 25$ °C $\pm 3$ °C

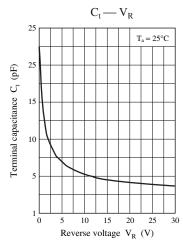
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Forward voltage	V <sub>F</sub>	$I_F = 200 \text{ mA}$		0.38	0.47	V
Reverse current	$I_{R1}$	$V_R = 10 \text{ V}$			20	μΑ
	I <sub>R2</sub>	$V_R = 30 \text{ V}$			200	
Terminal capacitance	Ct	$V_R = 0 \text{ V, } f = 1 \text{ MHz}$		25		pF
Reverse recovery time *	t <sub>rr</sub>	$I_F = I_R = 100 \text{ mA}$		2		ns
		$I_{rr} = 10 \text{ mA}, R_L = 100 \Omega$				

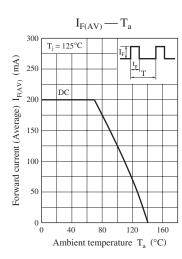
- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 measuring methods for diodes.
  - 2. This product is sensitive to electric shock (static electricity, etc.). Due attention must be paid on the charge of a human body and the leakage of current from the operating equipment.
  - 3. Absolute frequency of input and output is 250 MHz
  - 4. \*: t<sub>rr</sub> measurement circuit





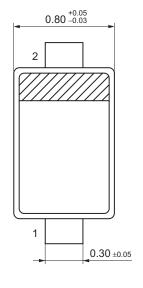


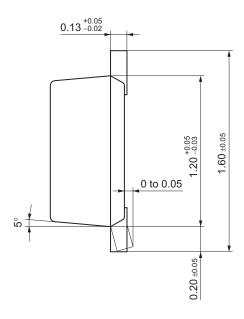


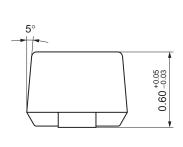


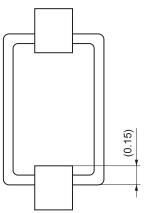
2 SKH00182AED

SSMini2-F4 Unit: mm









SKH00182AED 3

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